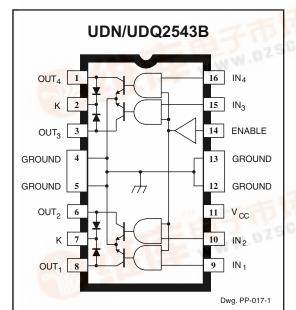
# 2543

Data Sheet **29317.2B** 

# PROTECTED QUAD POWER DRIVER



Providing interface between low-level logic and power loads to 100 W, the UDx2543B and UDx2543EB quad power drivers combine AND logic gates and high-current bipolar outputs. Each of the four independent outputs can sink up to 700 mA in the ON state. The outputs have a minimum breakdown voltage (load dump) of 60 V and a sustaining voltage of 35 V. The inputs are compatible with most TTL, DTL, LSTTL, and 5 V CMOS and PMOS logic systems.

Over-current protection has been designed into each channel of the UDx2543B/EB and typically occurs at 1 A. It protects any one channel from output short circuits with supply voltages up to 25 V. When the maximum output current is reached, that output stage is driven linearly. If the over-current condition continues, that output's thermal limiting will operate, limiting that output's power dissipation to approximately 2.4 W. The outputs also include diodes for voltage clamping with inductive loads such as relays, solenoids, or dc stepper motors.

These devices are supplied in a 16-pin power DIP of batwing construction (suffix 'B') to provide for maximum package power dissipation. They are also available in a 28-lead PLCC (suffix 'EB') for surface-mount applications. All devices are rated for continuous operation over the temperature range of -20°C to +85°C (UDN2543B/EB) or for use in automotive applications over an extended temperature range as the UDQ2543B/EB.

# ABSOLUTE MAXIMUM RATINGS at $T_A = 25^{\circ}C$

Output Voltage, V <sub>OUT</sub> <b>60 V</b>
Over-Current Protected Output Voltage,
V <sub>OUT</sub>
Output Current, I <sub>OUT</sub> 1.0 A*
Supply Voltage, V <sub>CC</sub> 7.0 V
Input Voltage, V <sub>IN</sub> or V <sub>EN</sub> <b>18 V</b>
Package Power Dissipation,
P <sub>D</sub> See Graph
Operating Temperature Range, T <sub>A</sub>
(UDN2543B/EB)20°C to +85°C
(UDQ2543B/EB)40°C to +85°C
Storage Temperature Range,
T 55°C to .150°C

\*Outputs are peak current limited at approximately 1.0 A per driver. See Circuit Description and Applications for further information.

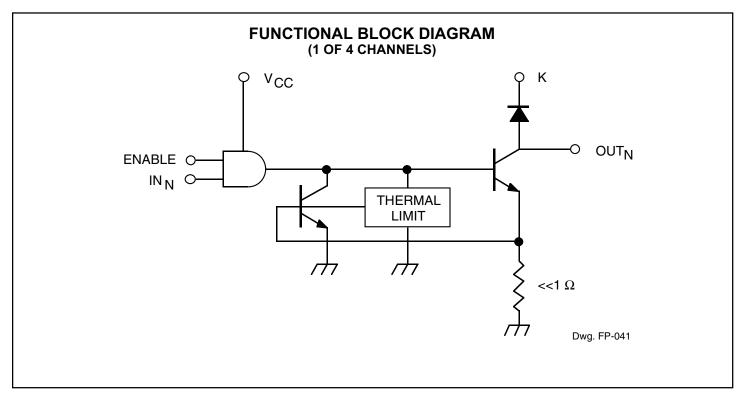
#### **FEATURES**

- 700 mA Output Current per Channel
- Low Output-Saturation Voltage
- Integral Output Transient-Suppression Diodes
- TTL, CMOS, PMOS, NMOS Compatible Inputs
- Independent Over-Current Protection for Each Output

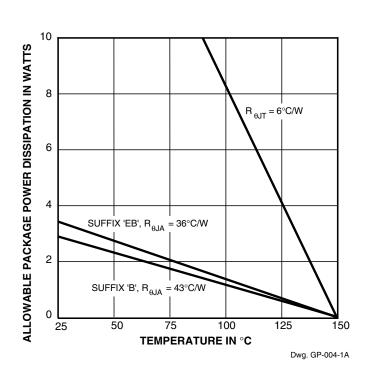
Always order by complete part number:

Part Number	Package	Operating Temperature
UDN2543B	16-Pin DIP	-20°C to +85°C
UDN2543EB	28-Lead PLCC	-20°C to +85°C
UDQ2543B	16-Pin DIP	-40°C to +85°C
UDQ2543EB	28-Lead PLCC	-40°C to +85°C

#71100x0°



NOTE: These devices do not include an absolute thermal shutdown. Package power dissipation under fault conditions (2.4 W in the faulted channel) must therefore be evaluated at maximum operating temperature.



# GROUND STATE OF THE STATE OF T

UDN/UDQ2543EB

# ELECTRICAL CHARACTERISTICS at $T_A$ = +25°C (UDN2543B/EB) or over operating temperature range (UDQ2543B/EB only), $V_{CC}$ = 4.75 V to 5.25 V

			Limits		
Characteristic	Symbol	Test Conditions	Min.	Max.	Units
Output Leakage Current	I <sub>CEX</sub>	$V_{OUT} = 60 \text{ V}, V_{IN} = 0.8 \text{ V}, V_{EN} = 2.0 \text{ V}$	_	100	μΑ
		$V_{OUT} = 60 \text{ V}, V_{IN} = 2.0 \text{ V}, V_{EN} = 0.8 \text{ V}$	_	100	μΑ
Output Sustaining Voltage	V <sub>OUT(SUS)</sub>	$I_{OUT} = 100 \text{ mA}, V_{IN} = V_{EN} = 0.8 \text{ V}$	35	_	٧
Output Saturation Voltage	V <sub>OUT(SAT)</sub>	$I_{OUT} = 100 \text{ mA}, V_{IN} = V_{EN} = 2.0 \text{ V}$	_	200	mV
		$I_{OUT} = 400 \text{ mA}, V_{IN} = V_{EN} = 2.0 \text{ V}$	_	400	mV
		$I_{OUT} = 700 \text{ mA}, V_{IN} = V_{EN} = 2.0 \text{ V}$	_	600	mV
Input Voltage	Logic 1	V <sub>IN(1)</sub> or V <sub>EN(1)</sub>	2.0	_	٧
	Logic 0	V <sub>IN(0)</sub> or V <sub>EN(0)</sub>	_	0.8	V
Input Current	Logic 1	$V_{IN(1)}$ or $V_{EN(1)} = 2.0 \text{ V}$	_	20	μΑ
	Logic 0	V <sub>IN(0)</sub> or V <sub>EN(0)</sub> = 0.8 V	_	-10	μΑ
Total Supply Current	I <sub>CC</sub>	$I_{OUT} = 700 \text{ mA*}, V_{IN}^{\dagger} = V_{EN} = 2.0 \text{ V}$	_	65	mA
		Outputs Open, $V_{IN}^{\dagger} = 0.8 \text{ V}, V_{EN} = 2.0 \text{ V}$	_	15	mA
Clamp Diode Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 1.0 A	_	1.6	٧
		I <sub>F</sub> = 1.5 A	_	2.0	٧
Clamp Diode	I <sub>R</sub>	$V_R = 60 \text{ V}, V_{IN} = V_{EN} = 2.0 \text{ V},$		50	μΑ
Leakage Current		$D_1 + D_2 \text{ or } D_3 + D_4$			

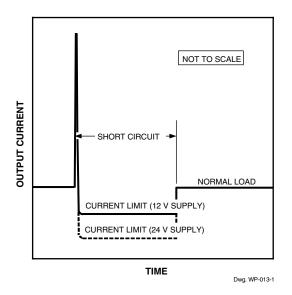
Negative current is defined as coming out of (sourcing) the specified terminal.

As used here, -100 is defined as greater than +10 (absolute magnitude convention) and the minimum is implicitly zero.

<sup>\*</sup> Pulse test, allowable package power dissipation will be exceeded at increased ambient temperatures.

<sup>†</sup> All inputs simultaneously, all other tests are performed with each input tested separately.

#### TYPICAL OUTPUT BEHAVIOR



#### CIRCUIT DESCRIPTION AND APPLICATION

#### **INCANDESCENT LAMP DRIVER**

For incandescent lamp applications, the UDx2549B/EB or UDx2559B/EB, with improved shortcircuit protection and thermal limiting, are recommended.

#### **INDUCTIVE LOAD DRIVER**

Bifilar (unipolar) stepper motors, relays, or solenoids can be driven directly. The internal flyback diodes prevent damage to the output transistors by suppressing the high-voltage spikes that occur when turning OFF an inductive load. For rapid current decay (fast turn-OFF speeds), the use of Zener diodes will raise the flyback voltage and improve performance. However, the peak voltage must not exceed the specified minimum sustaining voltage ( $V_{SUPPLY} + V_Z + V_F \le V_{OUT(SUS)}$ ).

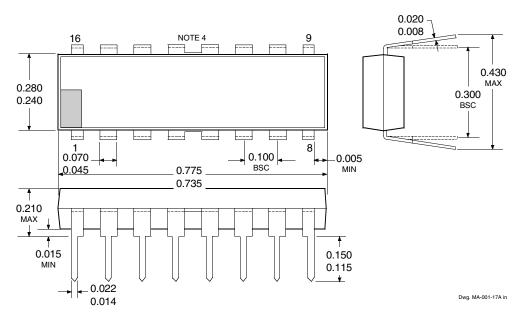
#### **FAULT CONDITIONS**

In the event of a shorted load, the load current will attempt to increase. As described above, the drive current to the affected output stage is diverted, causing the output stage to go linear, limiting the peak output current to approximately 1 A. As the power dissipation of that output stage increases, a thermal gradient sensing circuit will become operational, further decreasing the drive current to the affected output stage and reducing the output current to a value dependent on supply voltage ( $I_{OUT} \approx 2.4/V_{SUPPLY}$ ). If the fault condition is corrected, the output stage will return to its normal saturated condition.

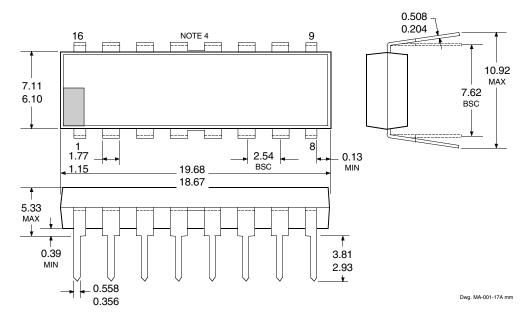
Due to the independent operation of the four channels, only a single channel should be shorted at a time. Multiple overload conditions may be tolerated provided rated package power dissipation is not exceeded.

#### UDN2543B and UDQ2543B

Dimensions in Inches (controlling dimensions)



#### **Dimensions in Millimeters** (for reference only)

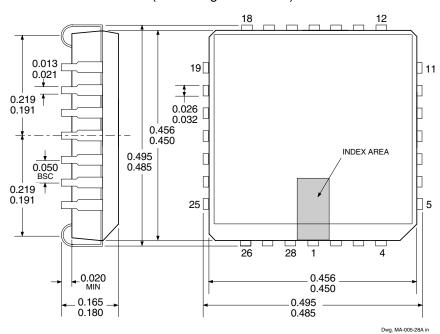


NOTES: 1. Exact body and lead configuration at vendor's option within limits shown.

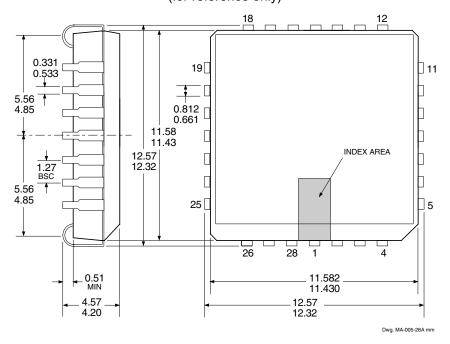
- Lead spacing tolerance is non-cumulative
   Lead thickness is measured at seating plane or below.
   Webbed lead frame. Leads 4, 5, 12, and 13 are internally one piece.

#### UDN2543EB and UDQ2543EB

Dimensions in Inches (controlling dimensions)



#### **Dimensions in Millimeters** (for reference only)



- NOTES: 1. Exact body and lead configuration at vendor's option within limits shown.
  2. Lead spacing tolerance is non-cumulative
  3. Webbed lead frame. Leads 5 through 11 and 19 through 25 are internally one piece.

The products described here are manufactured under one or more U.S. patents or U.S. patents pending.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.

Allegro products are not authorized for use as critical components in life-support devices or systems without express written approval.

The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringement of patents or other rights of third parties which may result from its use.

# **POWER SINK DRIVERS**

#### IN ORDER OF 1) OUTPUT CURRENT, 2) OUTPUT VOLTAGE, 3) NUMBER OF DRIVERS

Output Ratings *		Features						
——————————————————————————————————————		Serial	Latched	Diode		Internal	_ 	
mA	V	#	Input	<b>Drivers</b>	Clamp	Outputs	Protection	Part Number <sup>T</sup>
75	17	8	X	X		constant current	_	6275
400	17	16	X	X		constant current	_	6276
100	20 30	8 32	_ X	_ X	_	saturated	_	2595 5833
	40	32	x	x	_	saturated	_	5832
	50	8		ssable decod	der/driver	DMOS	_	6B259
	50	8	_	Χ	_	DMOS	_	6B273
	50	8	X	X		DMOS	_	6B595
250	50 50	8	addre	ssable decod	der/driver	DMOS DMOS	_	6259
	50 50	8 8	X	X X	_	DMOS	_	6273 6595
	135	7	_	_	Χ	_ _	_	7003
300	45	1	– Ha	III sensor/driv	er X	_	Х	5140
	50	7	_	_	X	_	_	2003
	50	8	_	_	X		_	2803
	50 60	8 4	_	_	X X	saturated	X	2596 2557
	95	4 7	_	_	X	saturated –	_	2023
	95	8	_	_	X	_	_	2823
350	50	4	_	Х	Х	_	_	5800
	50	7	_	_	X	_	_	2004
	50	8	_	_	X X X	_	_	2804
	50	8	_	X		_	_	5801 5924
	50 50	8 8	X X	X X	_ X	_	_	5821 5841
	50	8		ssable decod		DMOS	_	6A259
	50	8	X	Χ	_	DMOS	_	6A595
	80	8	X X	X	_	_	_	5822
	80	8	X	Χ	X	_	_	5842
	95 95	7 8	_	_	X X	_	_	2024 2824
450	30	28	dual 4	I- to 14-line d		ver –		6817
600	60	4	_	_	_	saturated	Х	2547
	60	4	_	_	Χ	saturated	â	2549
700	60	4	_	_	Х	saturated	X	2543 and 2559
750	50	8	_	_	Х	saturated	_	2597
900	14	2		II sensor/driv		saturated	X	3625
	26	2		ıll sensor/driv		saturated	Х	3626
1000	46	4		er motor conf			_	7024 and 7029
1200	46	4		stepping con				7042
1250	50 50	4 4		er motor tran –		er – –	X -	5804 2064 and 2068
1500	80	4			X			2065 and 2069
1800	50	4			X	_		2544
.555	50	4	_	_	X	_	_	2540
3000	46	4	stepp	er motor cont	roller/drive	er MOS	_	7026
	46	4	micro	stepping con	troller/drive	er MOS		7044
4000	50	4	_	_	X	_	_	2878
	80	4	_		X	_	_	2879

Current is maximum specified test condition, voltage is maximum rating. See specification for sustaining voltage limits or over-current protection voltage limits.

Complete part number includes additional characters to indicate operating temperature range and package style.

